

# 承认书

## SPECIFICATION FOR PRODUCT

客户名称  
Customer Name

客户料号  
Customer P/N

产品名称  
Product Name

仿贴片型采样电阻

制造商料号  
Manufacturer P/N

B0-6.3-0-2512

申请承认日期  
Apply Date

注意：禁止使用1级环境管理物质。遵守ACBEL“环境管理物质规范”中所要求之含量标准。

Note: Banned use of hazardous substances of level 1; Comply with "Specification for Hazardous Substances and Materials Management" of ACBEL

拟定 Draft	审核 Checked	批准 Approved	拟定 Draft	审核 Checked	批准 Approved
张雅兰	胡紫阳				
供货商印鉴 Vendor Stamp			客户承认印鉴 Customer Accepted and Stamp		

### 版本记录

#### Vision record

版本 Edition	日期 Date	版本更新记录 Version update record	核准 Approval
A1.0	2023/1/30	First issue	

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## 特征 Features

过电流能力强50A - 600A	Strong current load capacity 50A-600A
铜材散热能力强	Excellent thermal conductivity
可焊性好	Excellent Solderability
可编带包装	Taping packaging available
符合RoHS要求	RoHS compliant
特殊规格可以订做	Customizable



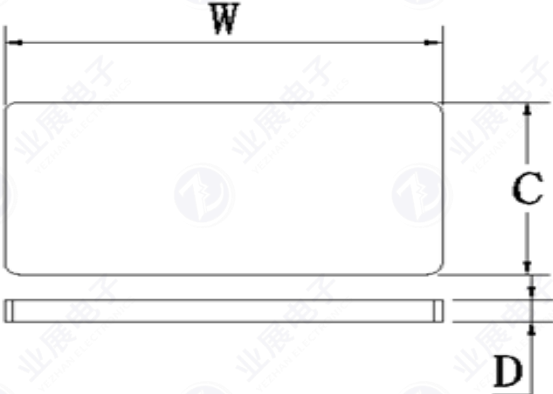
## 应用范围 Applications

散热	Heat Dissipation
导流	Diversion current
低电感电路	Low inductance
大电流脉冲电路	High current pulse circuit

## 订购信息 Ordering Information

B	0	-6.3	-0	-2512
Product Type	Power	W	R Value	Other
BSR-B	Watts	Pitch Unit: mm	Unit: mΩ	

» 产品尺寸和性能 Product Size And Performance

项目 Items	参数 Parameters
材料 Material	紫铜 Copper
图解 Diagrammatize	 <p>The diagram shows a rectangular component with a smaller rectangular feature on its bottom edge. Dimension W is the width of the main body, C is the height of the main body, and D is the thickness of the component.</p>
W	6.3mm±0.2mm
C	3.3mm±0.1mm
D	0.8mm±0.05mm
镀层厚度 Coating thickness	3μm~6μm
使用温度 Operating temperature	65°C ~ 170°C

## 耐久性测试 Endurance Test

项目 Items	极限值 Limits	技术条件 Additional Requirements
焊锡附着性 Solderability	导线至少95%以上新锡覆盖。 Covered with new solder by 95% at least.	焊锡温度: $245\pm 5^{\circ}\text{C}$ 。 浸锡时间: $5\pm 0.5$ 秒。 Test temperature of solder: $245\pm 5^{\circ}\text{C}$ Dipping time in solder: $5\pm 0.5\text{s}$

## 包装 Packaging

- 散装, 内外双包装 Bulk, Internal And External Package
- 或者编带包装 Or Taping Packaging

## 版本信息 Version History

版本 Version	日期 Date	修正描述 Description of amendment	备注 Remarks
A1.0	30-Jan-2023	First issue	